



**SLOVENSKI STANDARD**  
**SIST EN IEC 61784-1-3:2023**

**01-november-2023**

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**Industrijska omrežja - Profili - 1-3. del: Profili procesnih vodil - Komunikacijski profil skupine 3 (IEC 61784-1-3:2023)**

Industrial networks - Profiles - Part 1-3: Fieldbus profiles - Communication Profile Family 3 (IEC 61784-1-3:2023)

Industrielle Kommunikationsnetze - Profile - Teil 1-3: Feldbusprofile - Kommunikationsprofilfamilie (CPF) 3 (IEC 61784-1-3:2023)

Réseaux industriels - Profils - Part 1-3: Profils de bus de terrain - Famille de profils de communication 3 (IEC 61784-1-3:2023)

**Ta slovenski standard je istoveten z: EN IEC 61784-1-3:2023**

[SIST EN IEC 61784-1-3:2023](https://standards.kenia.gov/standards/sist/40201027-6010-4194-8003-951c99ac0a17/sist-en-iec-61784-1-3-2023)

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35.100.05	Večslojne uporabniške rešitve	Multilayer applications

**SIST EN IEC 61784-1-3:2023**

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EUROPEAN STANDARD  
NORME EUROPÉENNE  
EUROPÄISCHE NORM

**EN IEC 61784-1-3**

April 2023

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English Version

**Industrial networks - Profiles - Part 1-3: Fieldbus profiles -  
Communication Profile Family 3  
(IEC 61784-1-3:2023)**

Réseaux industriels - Profils - Part 1-3: Profils de bus de  
terrain - Famille de profils de communication 3  
(IEC 61784-1-3:2023)

Industrielle Kommunikationsnetze - Profile - Teil 1-3:  
Feldbusprofile - Kommunikationsprofilfamilie (CPF) 3  
(IEC 61784-1-3:2023)

This European Standard was approved by CENELEC on 2023-04-26. CENELEC members are bound to comply with the CEN/CENELEC Internal Regulations which stipulate the conditions for giving this European Standard the status of a national standard without any alteration.

Up-to-date lists and bibliographical references concerning such national standards may be obtained on application to the CEN-CENELEC Management Centre or to any CENELEC member.

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Comité Européen de Normalisation Electrotechnique  
Europäisches Komitee für Elektrotechnische Normung

**CEN-CENELEC Management Centre: Rue de la Science 23, B-1040 Brussels**

**EN IEC 61784-1-3:2023 (E)****European foreword**

The text of document 65C/1207/FDIS, future edition 1 of IEC 61784-1-3, prepared by SC 65C "Industrial networks" of IEC/TC 65 "Industrial-process measurement, control and automation" was submitted to the IEC-CENELEC parallel vote and approved by CENELEC as EN IEC 61784-1-3:2023.

The following dates are fixed:

- latest date by which the document has to be implemented at national (dop) 2024-01-26 level by publication of an identical national standard or by endorsement
- latest date by which the national standards conflicting with the (dow) 2026-04-26 document have to be withdrawn

This document, together with other parts of the same series, partially supersedes EN IEC 61784-1:2019 and all of its amendments and corrigenda (if any).

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The text of the International Standard IEC 61784-1-3:2023 was approved by CENELEC as a European Standard without any modification.

In the official version, for Bibliography, the following notes have to be added for the standard indicated:

- <https://standards.iteh.ai/catalog/standards/sist/en-iec-61784-1-3-2023>
- IEC 60079-14 NOTE Approved as EN 60079-14
- IEC 60793 (series) NOTE Approved as EN IEC 60793 (series)
- IEC 61131-3 NOTE Approved as EN 61131-3
- IEC 61158-1 NOTE Approved as EN IEC 61158-1
- IEC 61158-3 (series) NOTE Approved as EN 61158-3 (series)
- IEC 61158-4 (series) NOTE Approved as EN 61158-4 (series)
- IEC 61158-5 (series) NOTE Approved as EN 61158-5 (series)
- IEC 61158-5-10 NOTE Approved as EN IEC 61158-5-10
- IEC 61158-6 (series) NOTE Approved as EN 61158-6 (series)
- IEC 61158-6-10 NOTE Approved as EN IEC 61158-6-10
- IEC 61784-1 (series) NOTE Approved as EN IEC 61784-1 (series)
- IEC 61784-2 (series) NOTE Approved as EN IEC 61784-2 (series)

## Annex ZA (normative)

### Normative references to international publications with their corresponding European publications

The following documents are referred to in the text in such a way that some or all of their content constitutes requirements of this document. For dated references, only the edition cited applies. For undated references, the latest edition of the referenced document (including any amendments) applies.

NOTE 1 Where an International Publication has been modified by common modifications, indicated by (mod), the relevant EN/HD applies.

NOTE 2 Up-to-date information on the latest versions of the European Standards listed in this annex is available here: [www.cencenelec.eu](http://www.cencenelec.eu).

<u>Publication</u>	<u>Year</u>	<u>Title</u>	<u>EN/HD</u>	<u>Year</u>
IEC 60079-11	-	Electrical apparatus for explosive gas atmospheres - Part 11: Intrinsic safety "i"	EN 60079-11	-
IEC 60079-25	-	Explosive atmospheres - Part 25: Intrinsically safe electrical systems	EN IEC 60079-25	-
IEC 61010	series	Safety requirements for electrical equipment for measurement, control, and laboratory use	EN IEC 61010	series
IEC 61131-2	-	Industrial-process measurement and control - Programmable controllers - Part 2: Equipment requirements and tests	EN 61131-2	-
IEC 61158	series	Industrial communication networks - Fieldbus specifications	EN IEC 61158	series
IEC 61158-2	2023	Industrial communication networks - Fieldbus specifications - Part 2: Physical layer specification and service definition	EN IEC 61158-2	2023
IEC 61158-3-3	2014	Industrial communication networks - Fieldbus specifications - Part 3-3: Data-link layer service definition - Type 3 elements	EN 61158-3-3	2014
IEC 61158-4-3	2019	Industrial communication networks - Fieldbus specifications - Part 4-3: Data-link layer protocol specification - Type 3 elements	EN IEC 61158-4-3	2019
IEC 61158-5-3	2014	Industrial communication networks - Fieldbus specifications - Part 5-3: Application layer service definition - Type 3 elements	EN 61158-5-3	2014
IEC 61158-6-3	2019	Industrial communication networks - Fieldbus specifications - Part 6-3: Application layer protocol specification - Type 3 elements	EN IEC 61158-6-3	2019

**EN IEC 61784-1-3:2023 (E)**

IEC 61784-1-0	2023	Industrial networks - Profiles - Part 1-0: Fieldbus profiles - General concepts and terminology	EN IEC 61784-1-0	2023
IEC 61784-2-3	2023	Industrial networks - Profiles - Part 2-3: Additional real-time fieldbus profiles based on ISO/IEC/IEEE 8802-3 - CPF 3	EN IEC 61784-2-3	2023
ISO 15745-3	2003	Industrial automation systems and integration - Open systems application integration framework - Part 3: Reference description for IEC 61158 based control systems	-	-
TIA-485-A	1998	Electrical Characteristics of Generators and Receivers for Use in Balanced Digital Multipoint Systems	-	-

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IEC 61784-1-3

Edition 1.0 2023-03

# INTERNATIONAL STANDARD

# NORME INTERNATIONALE

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**Industrial networks – Profiles –  
Part 1-3: Fieldbus profiles – Communication Profile Family 3**

**Réseaux industriels – Profils –  
Partie 1-3: Profils de bus de terrain – Famille de profils de communication 3**

[SIST EN IEC 61784-1-3:2023](https://standards.iteh.ai/catalog/standards/sist/40201027-e8f0-4f94-8063-95fe99acba7/sist-en-iec-61784-1-3-2023)

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## INTERNATIONAL ELECTROTECHNICAL COMMISSION

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**INDUSTRIAL NETWORKS –  
PROFILES –****Part 1-3: Fieldbus profiles –  
Communication Profile Family 3****FOREWORD**

- 1) The International Electrotechnical Commission (IEC) is a worldwide organization for standardization comprising all national electrotechnical committees (IEC National Committees). The object of IEC is to promote international co-operation on all questions concerning standardization in the electrical and electronic fields. To this end and in addition to other activities, IEC publishes International Standards, Technical Specifications, Technical Reports, Publicly Available Specifications (PAS) and Guides (hereafter referred to as "IEC Publication(s)"). Their preparation is entrusted to technical committees; any IEC National Committee interested in the subject dealt with may participate in this preparatory work. International, governmental and non-governmental organizations liaising with the IEC also participate in this preparation. IEC collaborates closely with the International Organization for Standardization (ISO) in accordance with conditions determined by agreement between the two organizations.
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NOTE Combinations of protocol types are specified in the IEC 61784-1 series and the IEC 61784-2 series.

IEC 61784-1-3 has been prepared by subcommittee 65C: Industrial networks, of IEC technical committee 65: Industrial-process measurement, control and automation. It is an International Standard.

This first edition, together with the other parts of the same series, cancels and replaces the fifth edition of IEC 61784-1 published in 2019. This first edition constitutes a technical revision.

This edition includes the following significant technical changes with respect to IEC 61784-1:2019:

- a) split of the original IEC 61784-1 into several subparts, one subpart for the material of a generic nature, and one subpart for each Communication Profile Family specified in the original document.

The text of this International Standard is based on the following documents:

Draft	Report on voting
65C/1207/FDIS	65C/1236/RVD

Full information on the voting for its approval can be found in the report on voting indicated in the above table.

The language used for the development of this International Standard is English.

This document was drafted in accordance with ISO/IEC Directives, Part 2, and developed in accordance with ISO/IEC Directives, Part 1 and ISO/IEC Directives, IEC Supplement, available at [www.iec.ch/members\\_experts/refdocs](http://www.iec.ch/members_experts/refdocs). The main document types developed by IEC are described in greater detail at [www.iec.ch/publications](http://www.iec.ch/publications).

A list of all parts of the IEC 61784-1 series, published under the general title *Industrial networks – Profiles – Part 1: Fieldbus profiles*, can be found on the IEC website.

The committee has decided that the contents of this document will remain unchanged until the stability date indicated on the IEC website under [webstore.iec.ch](http://webstore.iec.ch) in the data related to the specific document. At this date, the document will be

- reconfirmed,
- withdrawn,
- replaced by a revised edition, or
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## INTRODUCTION

The IEC 61784-1 series provides a set of Communication Profiles (CP) in the sense of ISO/IEC TR 10000-1. These answer the need of identifying the protocol families co-existing within the IEC 61158 series, as a result of the international harmonization of fieldbus technologies available on the market. More specifically, these profiles help to correctly state the compliance with the IEC 61158 series, and to avoid the spreading of divergent implementations, which would limit its use, clearness and understanding. Additional profiles to address specific market concerns, such as functional safety or information security, can be addressed by future parts of the IEC 61784-1 series.

The IEC 61784-1 series contains several Communication Profile Families (CPF), which specify one or more communication profiles. Such profiles identify, in a strict sense, protocol subsets of the IEC 61158 series via protocol specific communication profiles. They do not define device profiles that specify communication profiles together with application functions needed to answer the need of a specific application ("application profiles").

It is agreed that these latter classes of profiles would facilitate the use of the IEC 61158 series of standards; the profiles defined in the IEC 61784-1 series are a necessary step to achieve that task.

It is also important to clarify that interoperability – defined as the ability of two or more network systems to exchange information and to make mutual use of the information that has been exchanged (see ISO/IEC TR 10000-1) – can be directly achieved on the same link only for those devices complying with the same communication profile.

Profiles contained in the IEC 61784-1 series are constructed of references to IEC 61158-2 and the IEC 61158-3, IEC 61158-4, IEC 61158-5 and IEC 61158-6 series, and other IS, TS or worldwide-accepted standards, as appropriate<sup>1</sup>. Each profile is required to reference at least one part of the IEC 61158 series in addition to IEC 61158-1.

Two or more Profiles, which are related to a common family, are specified within a "Communication Profile Family" (CPF).

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<sup>1</sup> International Standardised Profiles may contain normative references to specifications other than International Standards; see ISO/IEC JTC 1 N 4047: *The Normative Referencing of Specifications other than International Standards in JTC 1 International Standardized Profiles – Guidelines for ISP Submitters*.